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**InterNational Committee for Information Technology Standards (INCITS)**

Secretariat: Information Technology Industry Council (ITI)

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To: INCITS Members

Reply To: [Deborah J. Spittle](#)

Subject: Public Review and Comments Register for the Reaffirmations of:

INCITS/ISO/IEC 15414:2006[2009], Information technology - Open distributed processing - Reference model - Enterprise language

INCITS/ISO/IEC 11574:2000[2009], Information technology - Telecommunications and information exchange between systems - Private Integrated Services Network - Circuit-mode 64 kbit/s bearer services - Service description, functional capabilities and information flows

INCITS/ISO/IEC 10021-8:1999 [2009], Information technology -- Message Handling Systems (MHS) -- Part 8: Electronic Data Interchange Messaging Service

INCITS/ISO/IEC 10021-9:1999[2009], Information technology -- Message Handling Systems (MHS): Electronic Data Interchange Messaging System -- Part 9

**Due Date: The public review is from May 9, 2014 to June 23, 2014.**

Action: The InterNational Committee for Information Technology Standards ([INCITS](#)) announces that the subject-referenced document(s) is being circulated for a 45-day public review and comment period. Comments received during this period will be considered and answered. Commenters who have objections/suggestions to this document should so indicate and include their reasons.

All comments should be forwarded not later than the date noted above to the following address:

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*This public review also serves as a call for patents and any other pertinent issues (copyrights, trademarks). Correspondence regarding intellectual property rights may be emailed to the INCITS Secretariat at [patents@itic.org](mailto:patents@itic.org).*